

Supplementary Materials

**Aggregation, Sedimentation, and Dissolution of
Copper Oxide Nanoparticles: Influence of Low-
Molecular-Weight Organic Acids from Root
Exudates**

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20 **Number of pages:** 6

21 **Number of Figures:** 4

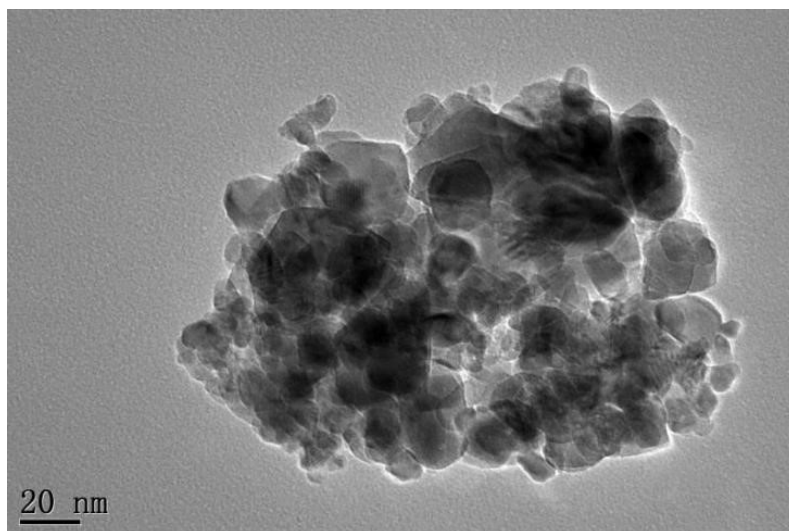


Figure S1. TEM image of CuO NPs

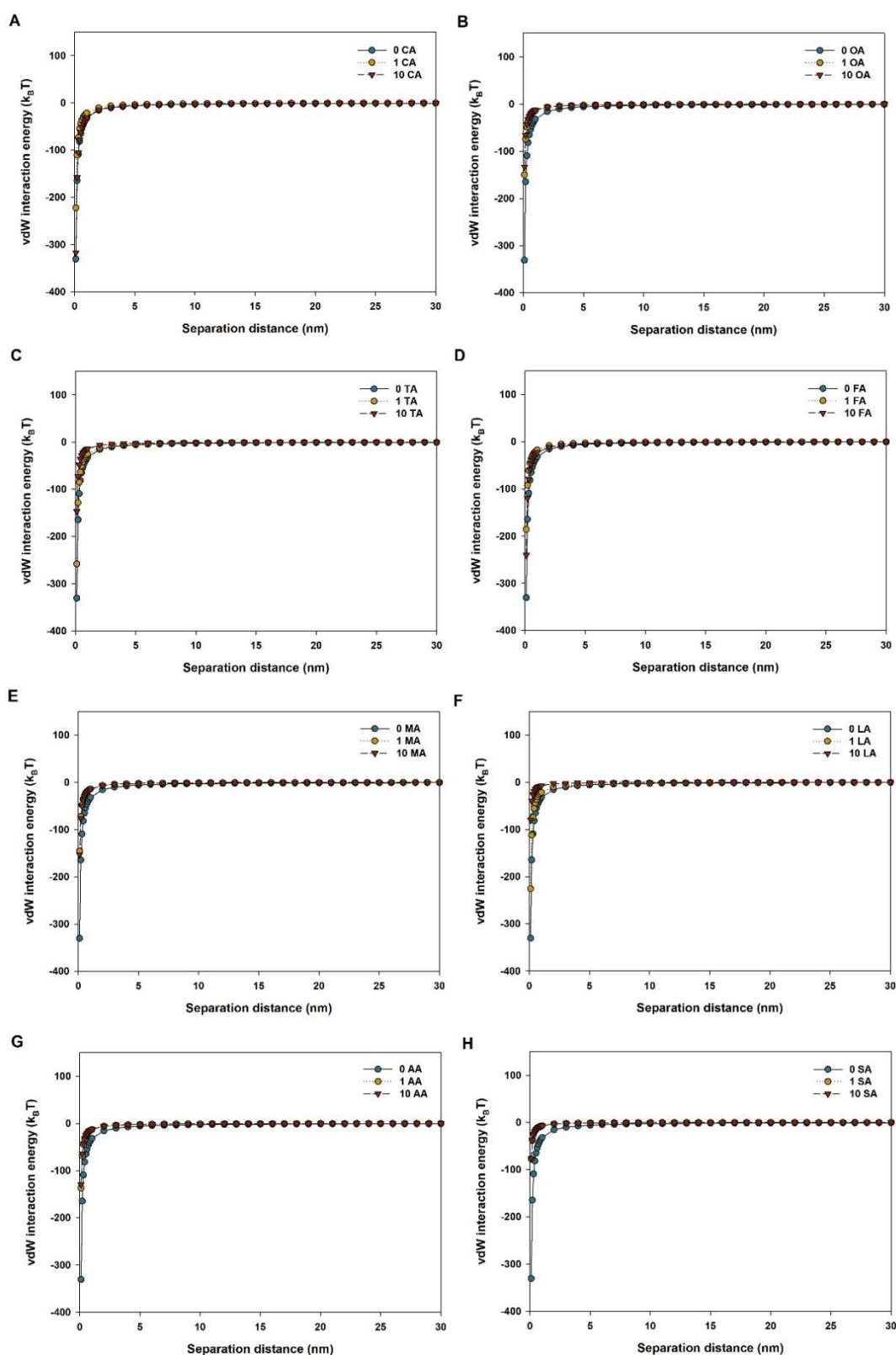


Figure S2. Calculated vdW interaction energy between two CuO NPs under varying LMWOAs. (A) CA: Citric acid; (B) OA: Oxalic acid; (C) TA: Tartaric acid; (D) FA: Formic acid; (E) MA: Malic acid; (F) LA: Lactic acid; (G) AA: Acetic acid; (H) SA: Succinic acid.

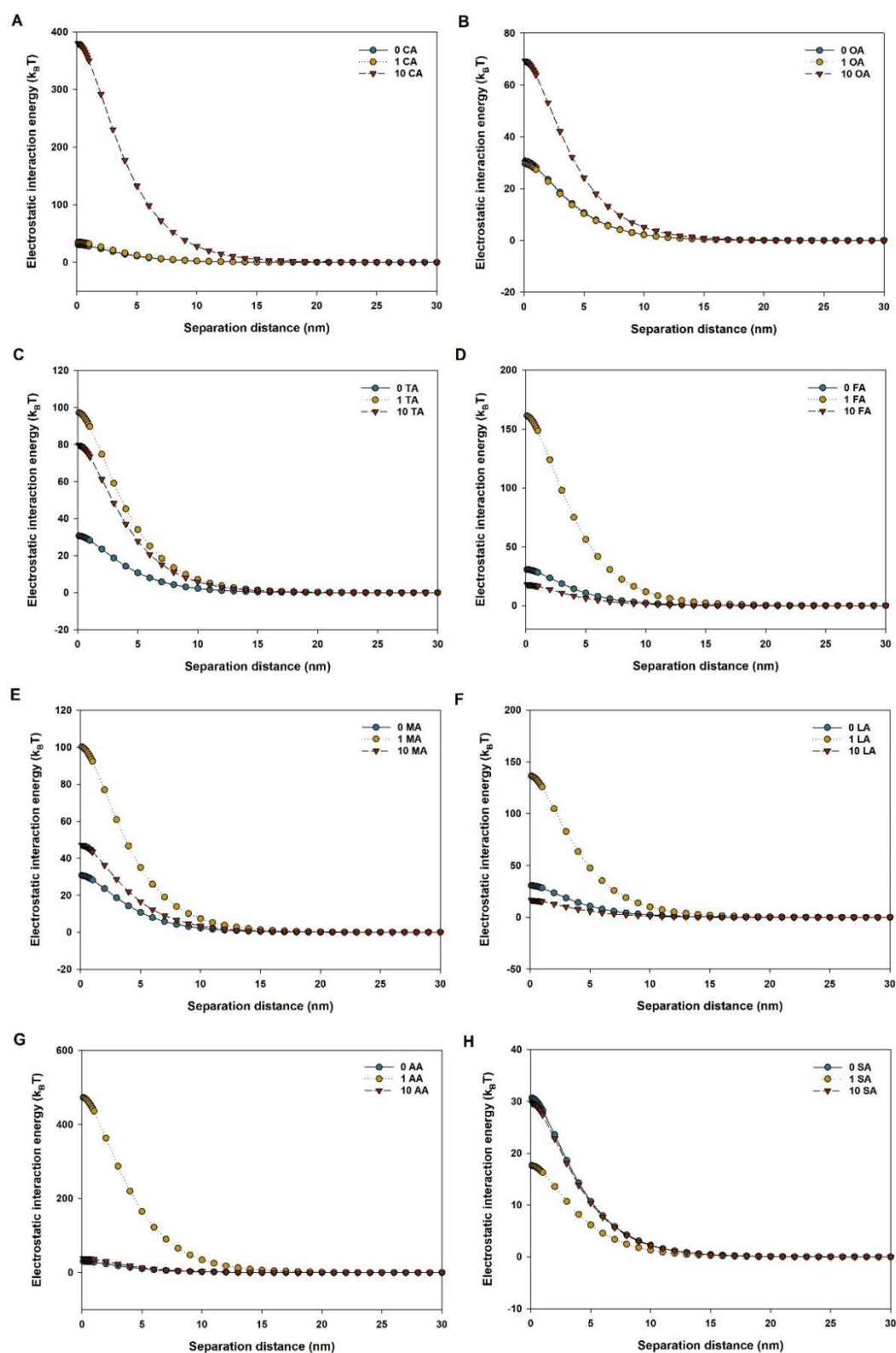


Figure S3. Calculated electrostatic interaction energy between two CuO NPs under varying LMWOAs. (A) CA: Citric acid; (B) OA: Oxalic acid; (C) TA: Tartaric acid; (D) FA: Formic acid; (E) MA: Malic acid; (F) LA: Lactic acid; (G) AA: Acetic acid; (H) SA: Succinic acid.

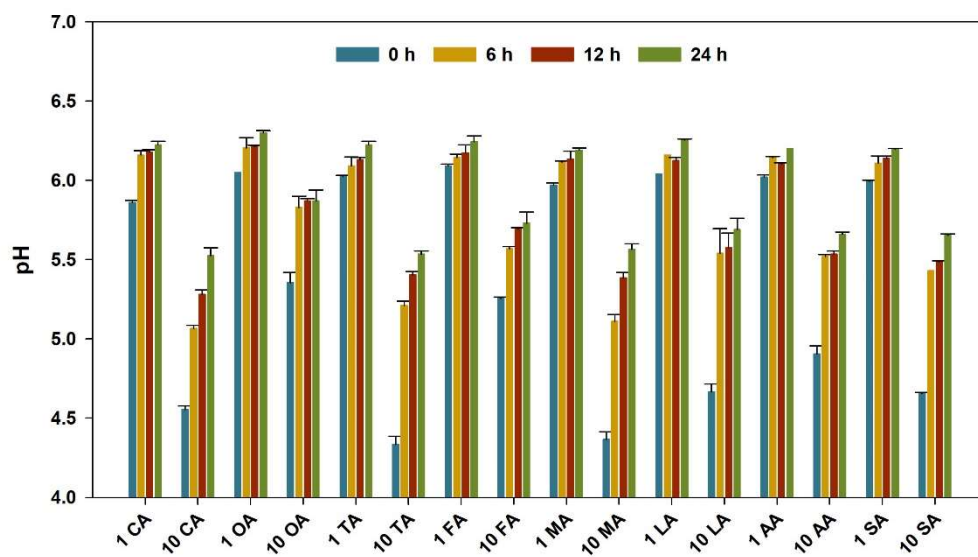


Figure S4. The dynamic pH of CuO NP suspension with varying LMWOAs. CA: Citric acid; OA: Oxalic acid; TA: Tartaric acid; FA: Formic acid; MA: Malic acid; LA: Lactic acid; AA: Acetic acid; SA: Succinic acid.